



General Description

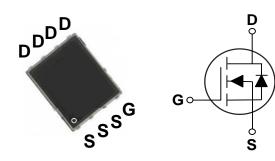
These N-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

BV _{DSS}	R _{DS(ON)}	I _D
40V	5.5mΩ	90A

Features

- 40V, 90A, $R_{DS(ON)}$ =5.5m Ω @ V_{GS} =10V
- · Fast switching
- · Improved dv/dt capability
- · Green Device Available

PPAK5X6 Pin Configuration



Applications

- Notebook
- · Load Switch
- · LED applications
- · Hand-Held Device

Absolute Maximum Ratings T_C=25°C unless otherwise noted **Symbol Parameter** Rating **Units** V_{DS} Drain-Source Voltage 40 ٧ V_{GS} Gate-Source Voltage ±20 90 Drain Current - Continuous (T_C=25°C) Α I_{D} 57 Α Drain Current - Continuous (T_C=100°C) I_{DM} Drain Current - Pulsed (NOTE 1) 360 Α 83 W Power Dissipation (T_C=25°C) P_{D} 0.67 Power Dissipation - Derate above 25°C W/°C T_{J} Operating Junction Temperature Range -50 to 150 ٥С Storage Temperature Range -50 to 150 T_{STG} ٥С Marking Code ND5P5 / DC4904X

Thermal Characteristics					
Symbol Parameter		Тур.	Max.	Unit	
$R_{\theta JA}$	Thermal Resistance Junction to Ambient		62	°C/W	
$R_{ heta JC}$	Thermal Resistance Junction to Case		1.5	°C/W	





Electrical Characteristics (T_i=25°C, unless otherwise noted)

Off Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V_{GS} =0V , I_D =250uA	40			V
I _{DSS}	IDrain-Source Leakage Current	V_{DS} =40V , V_{GS} =0V , T_j =25 $^{\circ}$ C			1	uA
		V_{DS} =32V , V_{GS} =0V , T_{j} =85 $^{\circ}$ C			10	uA
I _{GSS}	Gate-Source Leakage Current	V_{GS} =±20V , V_{DS} =0V			±100	nA

On Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =10V , I _D =20A		4.2	5.5	mΩ
		V _{GS} =4.5V , I _D =10A		5.3	7	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS}=V_{DS}$, $I_D=250uA$	1.0	1.6	2.5	V
gfs	Forward Transconductance	V_{DS} =10V , I_D =10A		16		S

Dynamic and switching Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Q_g	Total Gate Charge (NOTE 2 · 3)			25	50	
Q_gs	Gate-Source Charge (NOTE 2 \cdot 3)	V_{DS} =32V , V_{GS} =4.5V , I_{D} =10A		6.4	13	nC
Q_{gd}	Gate-Drain Charge (NOTE 2 \ 3)			12.1	24	
$T_{d(on)}$	Turn-On Delay Time (NOTE 2 \ 3)			14.2	28	
T _r	Rise Time (NOTE 2 \cdot 3)	V_{DD} =20V , V_{GS} =10V , R_{G} =3.3 Ω		18.3	36	ne
$T_{d(off)}$	Turn-Off Delay Time (NOTE 2 \ 3)	, I _D =1A		38.8	76	ns
T_f	Fall Time (NOTE 2 \ 3)			13.9	28	
C _{iss}	Input Capacitance			2410	3600	
C _{oss}	Output Capacitance	V_{DS} =25V , V_{GS} =0V , F=1MHz		233	400	pF
C _{rss}	Reverse Transfer Capacitance			152	230	
Rg	Gate resistance	V_{GS} =0V , V_{DS} =0V , F=1MHz		1.6	3.2	Ω

Drain-Source Diode Characteristics and Ratings

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Is	Continuous Source Current	V _G =V _D =0V , Force Current			90	Α
I _{SM}	Pulsed Source Current				180	Α
V_{SD}	Diode Forward Voltage	V_{GS} =0V , I_{S} =1A , T_{J} =25 $^{\circ}$ C			1	V

NOTES:

- 1. Repetitive Rating: Pulsed width limited by maximum junction temperature.
- 2. The data tested by pulsed , pulse width \leq 300us , duty cycle \leq 2%.
- ${\it 3. Essentially independent of operating temperature.}\\$





Characteristics Curves

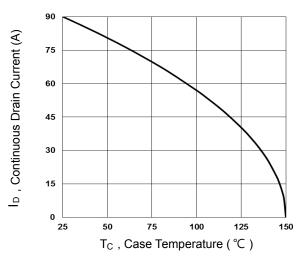


Fig.1 Continuous Drain Current vs. Tc

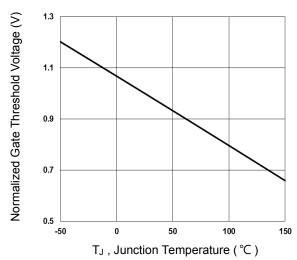


Fig.3 Normalized V_{th} vs. T_J

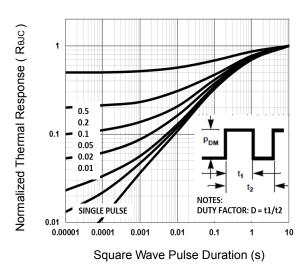


Fig.5 Normalized Transient Impedance

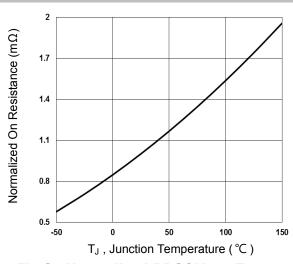


Fig.2 Normalized RDSON vs. T_J

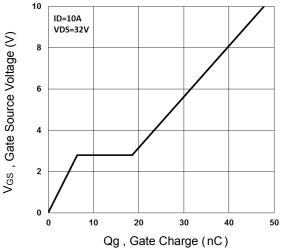


Fig.4 Gate Charge Waveform

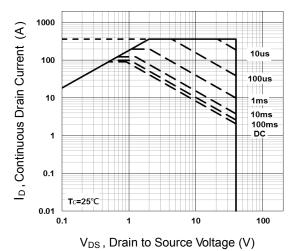


Fig.6 Maximum Safe Operation Area





Characteristics Curves

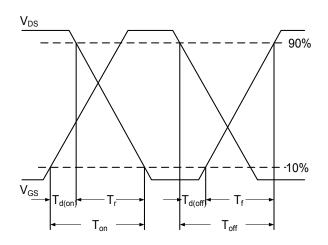


Fig.7 Switching Time Waveform

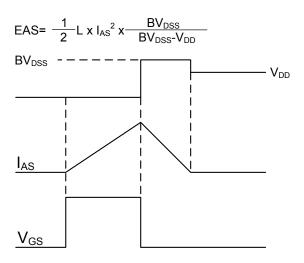
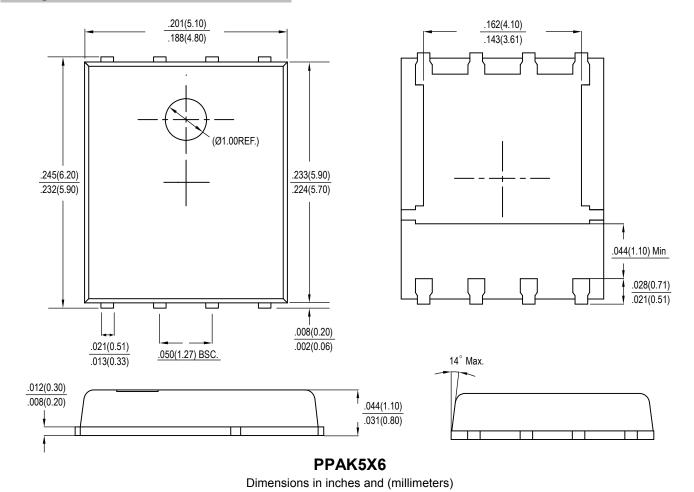


Fig.8 EAS Waveform

Package Outline Dimensions







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